

# **MOSFET**

## OptiMOS<sup>™</sup> 5 Power-Transistor, 30 V

### **Features**

- Very low on-resistance  $R_{\text{DS(on)}}$  @ V\_Gs=4.5 V 100% avalanche tested Superior thermal resistance

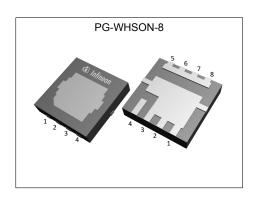
- N-channel, logic level
- Optimized for high performance SMPS, e.g. sync.rec.
  Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

**Kev Performance Parameters** Table 1

Parameter	Value	Unit
<b>V</b> <sub>DS</sub>	30	V
R <sub>DS(on),max</sub>	0.85	mΩ
$I_{D}$	252	A
Qoss	31	nC
Q <sub>G</sub> (0V4.5V)	30	nC











Type / Ordering Code	Package	Marking	Related Links
IQE008N03LM5SC	PG-WHSON-8	В	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 30 V



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# OptiMOS<sup>™</sup> 5 Power-Transistor, 30 V IQE008N03LM5SC



1 Maximum ratings at  $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Damanastan	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	252 159 147 38	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =60°C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1008	Α	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	50	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-16	-	16	V	-	
Power dissipation	P <sub>tot</sub>	-	-	89 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>2)</sup>	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	-	

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

Doromotor	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	-	-	1.4	°C/W	-
Thermal resistance, junction - case, top	R <sub>thJC</sub>	-	0.7	-	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	60	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 5 Power-Transistor, 30 V IQE008N03LM5SC



## 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	30	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.2	1.6	2.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 250 \ \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1.0 100	μΑ	V <sub>DS</sub> =24 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =24 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.65 0.80	0.85 1.00	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =20 A
Gate resistance	R <sub>G</sub>	-	0.7	-	Ω	-
Transconductance	<b>g</b> fs	-	190	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Devementar	Symbol	Values			11	Note / Took Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	4400	5700	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =15 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1100	1400	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	110	190	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	19	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	38	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	32	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	9.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Cumbal	Values			l lmi4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	10	-	nC	$V_{DD}$ =15 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate charge at threshold	Q <sub>g(th)</sub>	-	7	-	nC	$V_{DD}$ =15 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	6	9	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	9.1	-	nC	$V_{DD}$ =15 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	30	38	nC	$V_{DD}$ =15 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.3	-	V	$V_{DD}$ =15 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V
Gate charge total	Qg	-	64	-	nC	V <sub>DD</sub> =15 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	28	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 4.5 V
Output charge <sup>1)</sup>	Qoss	-	31	41	nC	V <sub>DS</sub> =15 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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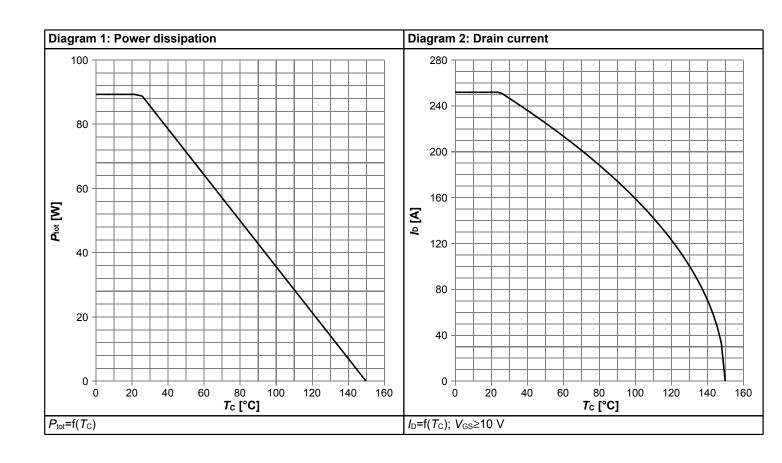


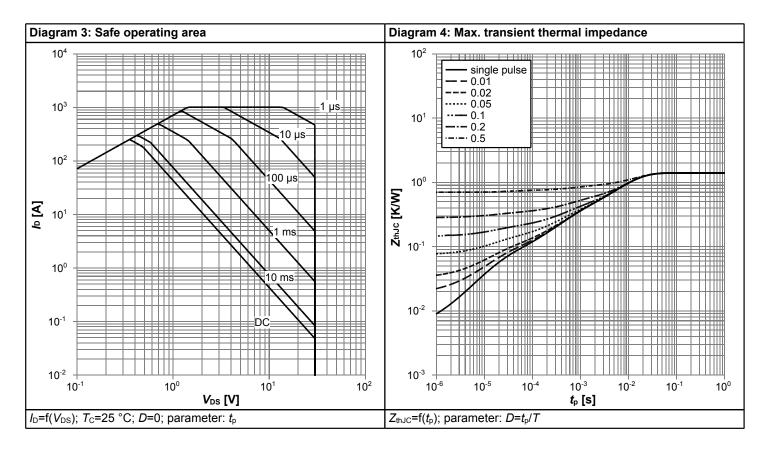
## Table 7 Reverse diode

Parameter	Symbol		Values			Nata / Tant Canalitian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	81	Α	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	1008	Α	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.73	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	34	68	ns	V <sub>R</sub> =15 V, I <sub>F</sub> =20 A, di <sub>F</sub> /dt=100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	27	54	nC	$V_R$ =15 V, $I_F$ =20 A, $di_F/dt$ =100 A/ $\mu$ s

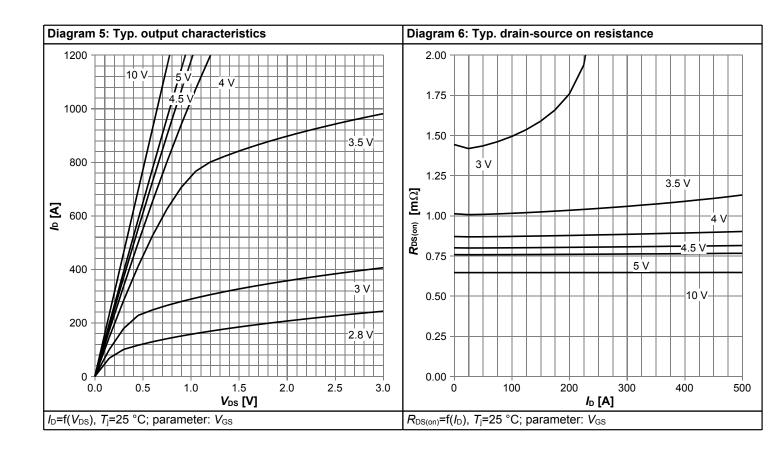


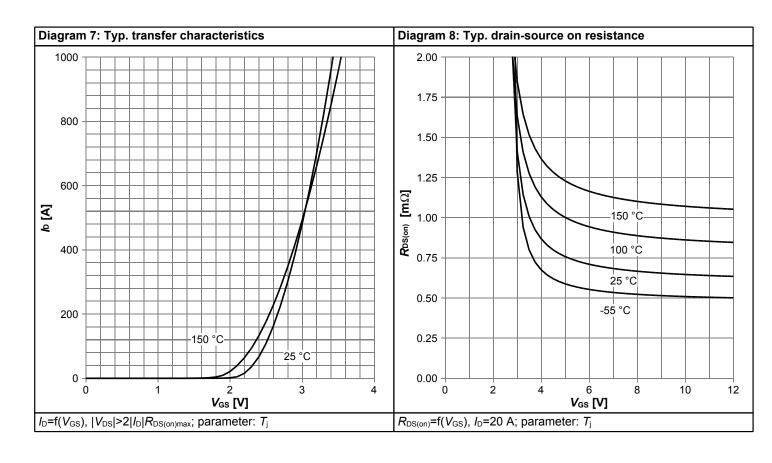
# 4 Electrical characteristics diagrams



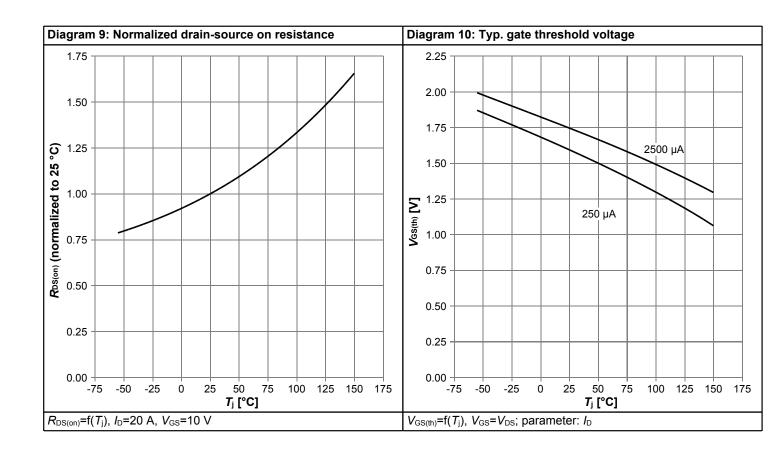


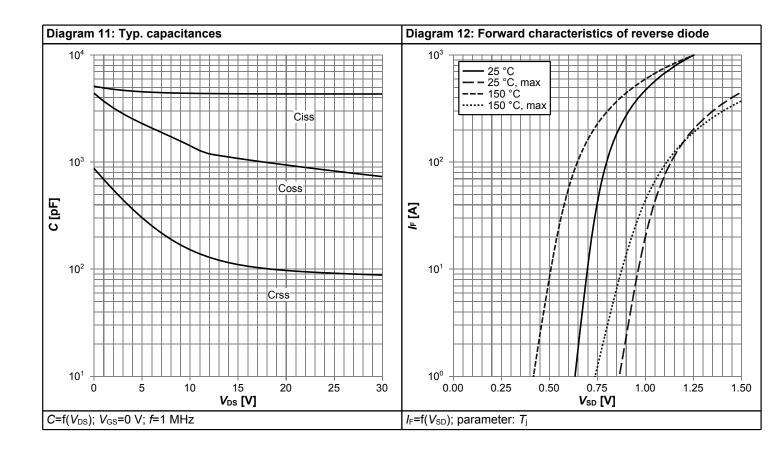




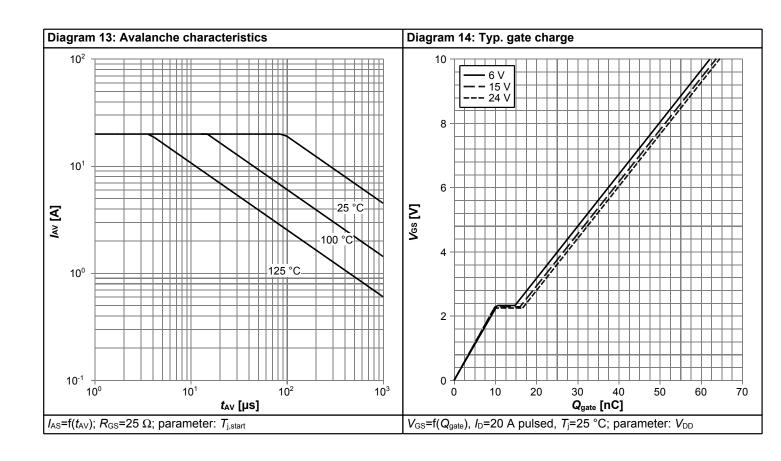


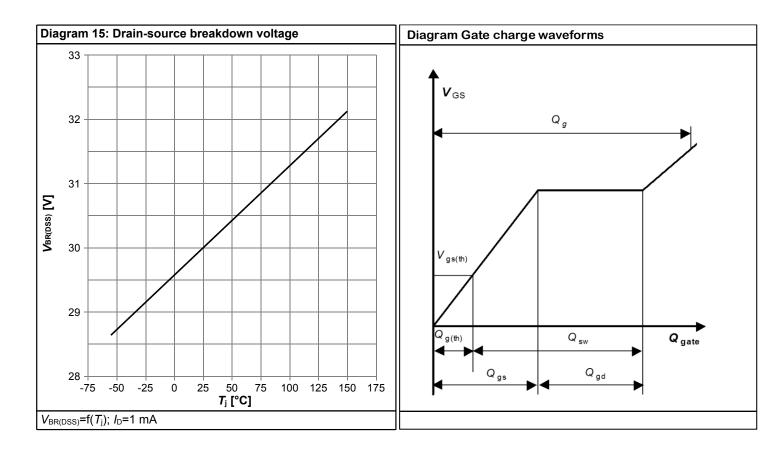














# 5 Package Outlines

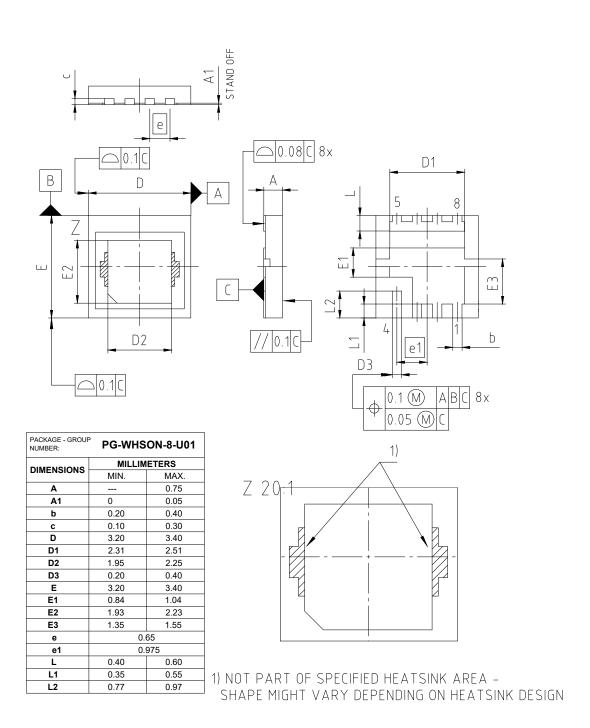


Figure 1 Outline PG-WHSON-8, dimensions in mm

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### **Revision History**

IQE008N03LM5SC

Revision: 2023-03-29, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-03-29	Release of final version

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Final Data Sheet 11 Rev. 2.0, 2023-03-29